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Front Matter: Volume 7290

, "Front Matter: Volume 7290," Proc. SPIE 7290, Industrial and Commercial Applications of Smart Structures Technologies 2009, 729001 (23 April 2009); doi: 10.1117/12.830976

SPIE.

Event: SPIE Smart Structures and Materials + Nondestructive Evaluation and Health Monitoring, 2009, San Diego, California, United States

PROCEEDINGS OF SPIE

Industrial and Commercial Applications of Smart Structures Technologies 2009

**Benjamin K. Henderson
M. Brett McMickell**
Editors

**9–10 March 2009
San Diego, California, United States**

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Published by
SPIE

Volume 7290

Proceedings of SPIE, 0277-786X, v. 7290

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Please use the following format to cite material from this book:

Author(s), "Title of Paper," in *Industrial and Commercial Applications of Smart Structures Technologies 2009*, edited by Benjamin K. Henderson, M. Brett McMickell, Proceedings of SPIE Vol. 7290 (SPIE, Bellingham, WA, 2009) Article CID Number.

ISSN 0277-786X

ISBN 9780819475503

Published by

SPIE

P.O. Box 10, Bellingham, Washington 98227-0010 USA

Telephone +1 360 676 3290 (Pacific Time) · Fax +1 360 647 1445

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Printed in the United States of America.

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